

### 描述 / Descriptions

SOT-23 塑封封装 NPN 半导体三极管。Silicon NPN transistor in a SOT-23 Plastic Package.

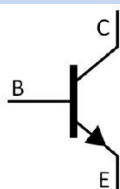
### 特征 / Features

高频率。  
High  $f_T$ .

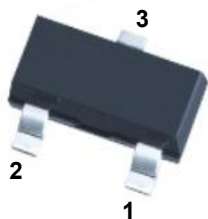
### 用途 / Applications

用于普通高频放大。  
High frequency general-purpose amplifier applications.

### 内部等效电路 / Equivalent Circuit



### 引脚排列 / Pinning



PIN 1 : Emitter      PIN 2 : Base      PIN 3 : Collector

### 放大及印章代码 / $h_{FE}$ Classifications & Marking

$h_{FE}$ Classifications Symbol	2	3	4
$h_{FE}$ Range	40~80	60~120	90~180
Marking	HJ2	J3H	HJ4

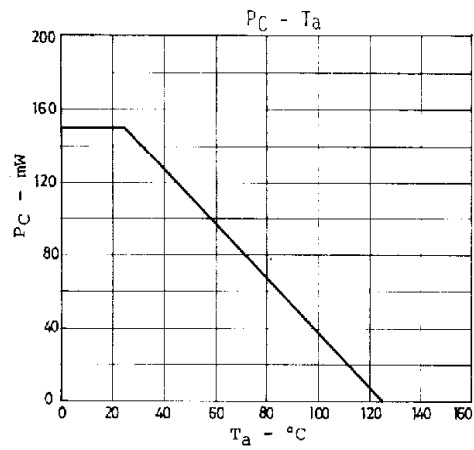
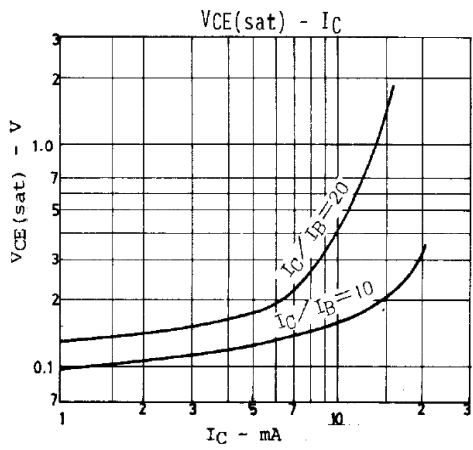
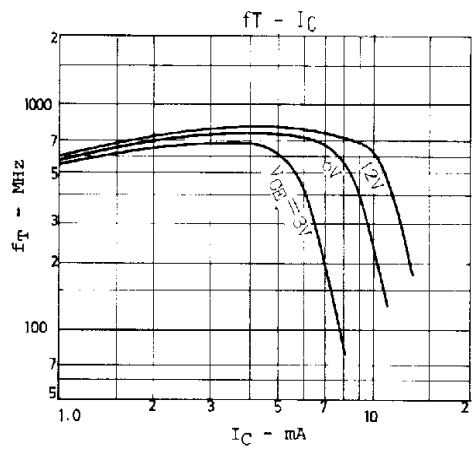
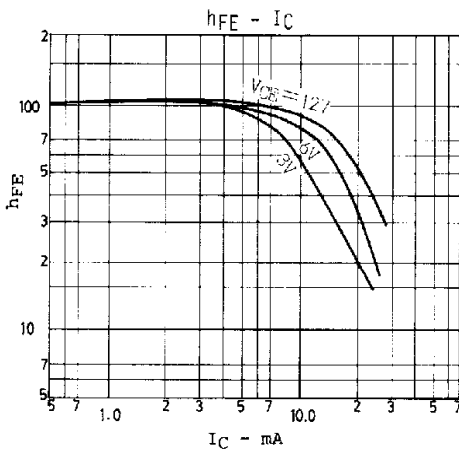
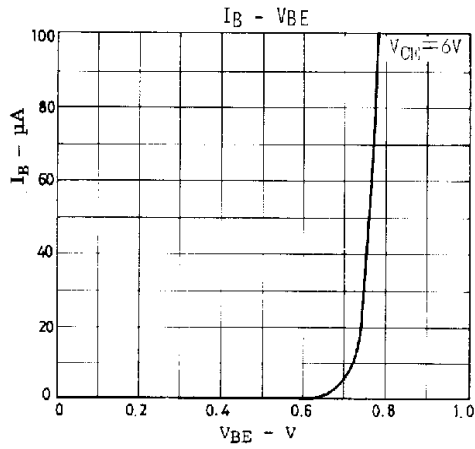
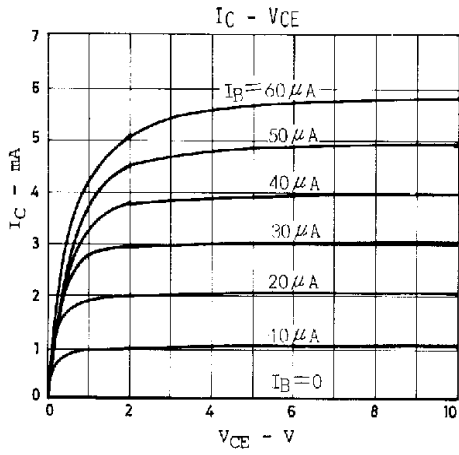
**极限参数 / Absolute Maximum Ratings(Ta=25°C)**

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Collector to Base Voltage	$V_{CBO}$	25	V
Collector to Emitter Voltage	$V_{CEO}$	20	V
Emitter to Base Voltage	$V_{EBO}$	3.0	V
Collector Current	$I_C$	30	mA
Collector Power Dissipation	$P_C$	150	mW
Junction Temperature	$T_j$	150	°C
Storage Temperature Range	$T_{stg}$	-55~150	°C

**电性能参数 / Electrical Characteristics(Ta=25°C)**

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Collector Cut-Off Current	$I_{CBO}$	$V_{CB}=10V$ $I_E=0$			0.1	μA
Emitter Base Cut-Off Current	$I_{EBO}$	$V_{EB}=3.0V$ $I_C=0$			0.1	μA
DC Current Gain	$h_{FE}$	$V_{CE}=6.0V$ $I_C=1.0mA$	40		180	
Transition Frequency	$f_T$	$V_{CE}=6.0V$ $I_C=4.0mA$	450	750		MHz
Noise Figure	NF	$V_{CE}=6.0V$ $I_C=1.0mA$ $f=100MHz$		2.2		dB
Collector-base parameter	$r_{bb'Cc}$	$V_{CB}=6.0V$ $I_C=1.0mA$ $f=31.9MHz$			19	ps
Gate Dissipation	$P_G$	$V_{CE}=6.0V$ $I_C=1.0mA$ $f=100MHz$		28		dB
Reverse transfer capacitance (Common emitter)	$C_{re}$	$V_{CB}=6.0V$ $f=1.0MHz$		0.6	0.9	pF

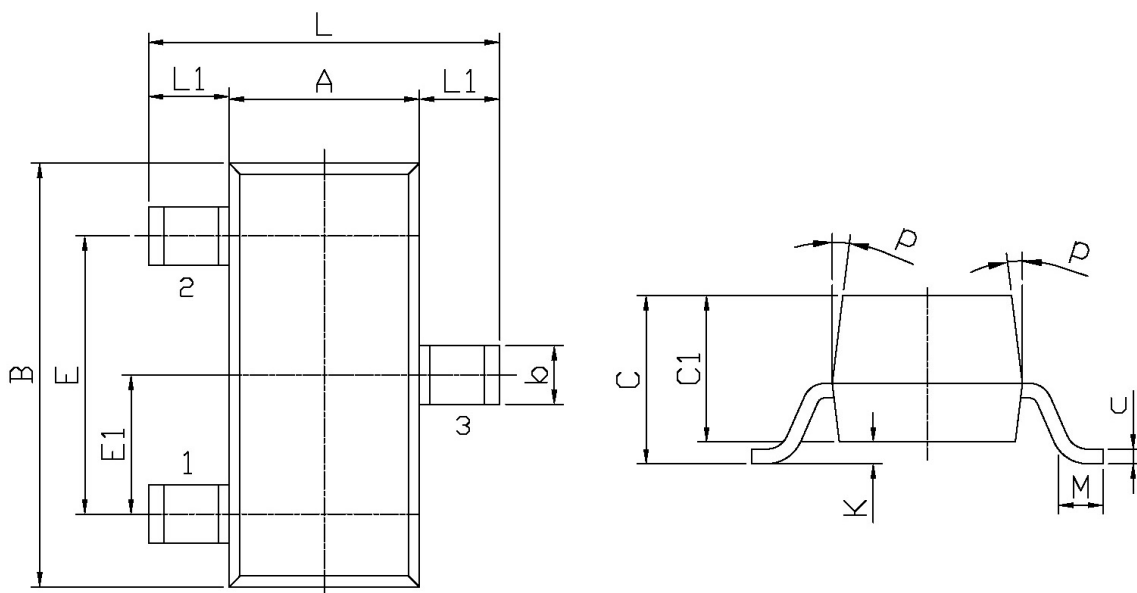
电参数曲线图 / Electrical Characteristic Curve



外形尺寸图 / Package Dimensions

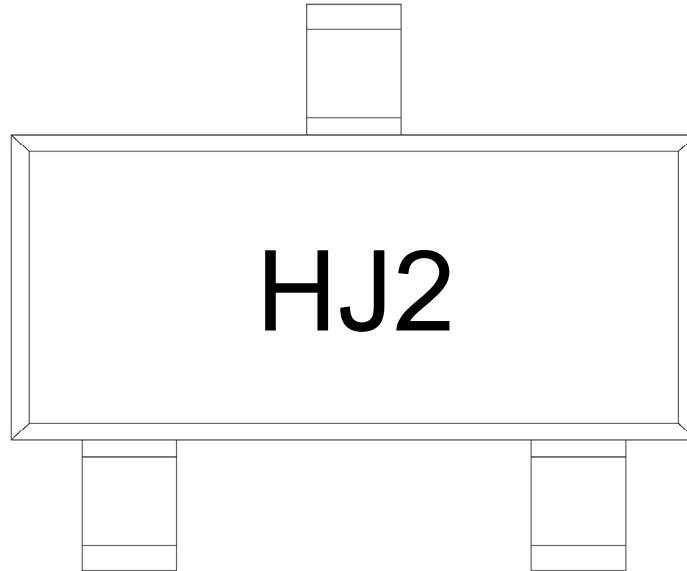
SOT-23

单位: mm



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.90	1.20
A	1.15	1.50	c	0.05	0.20
B	2.70	3.10	K	0	0.10
E	1.70	2.10	M	0.20MIN	
E1	0.85	1.05	P	7°	
b	0.35	0.55			

印章说明 / Marking Instructions



说明：

- H： 为公司代码
- J： 为型号代码
- 2： 为  $h_{FE}$  档次代码

Note:

- H： Company Code
- J： Product Type Code
- 2：  $h_{FE}$  Classifications Symbol Code

**回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)**



说明：

- 1、预热温度 25~150°C，时间 60~90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2~10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

**耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions**

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

**包装规格 / Packaging SPEC.**

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm <sup>3</sup> )		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	8	240,000	7" x8	180×120×180	385×257×392

**使用说明 / Notices**